

VT-47

High Tg Material

Datasheets

VT-47TC/Laminate VT-47PP/Prepreg

General Information

- High Tg FR-4(>170 °C)
- Phenolic Cured System
- Excellent Thermal Reliability
- UV Blocking;
- Laser Fluorescing;
- Low CTE

Application

For Single Side\Double Side\ Multilayer PWB & **Lead Free Assembly Applications;**

Availability

VT-47TC Laminates are available in thickness from .002"to .200" and with the copper foil from 1/4oz to 12oz; Ventec can supply either reverse treated (RT) or double side treated copper foil. On cores ≤ .005", it is recommended to use the reverse treated copper due to the low profile. The peel strength for RT foil is ≈1-2lbs/in (0.35Kg/m) less than Standard foil.

VT-47PP pre-pregs are available in many E-Glass styles, such as 7628, 7629, 1506, 1500, 2113, 2313, 3313, 2116, 1080, 1086, 1078, 106 & 1067.

Storage Condition & Shelf Life

| | | Prepreg | | Laminate |
|------------|-------------------|------------------|-----------------|-------------------|
| Storage | Temperature | Below 22°C(73°F) | Below 5°C(41°F) | Below 22°C(73°F) |
| Condition | Relative Humidity | Below 55%RH | / | Below 55%RH |
| Shelf Life | | 3 Month | 6 Month | 12Month(airproof) |



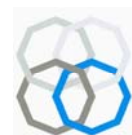
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Properties Sheet: IPC-4101B Specification Sheet(s)/21,24,26, 97, 98, 99, 101, 121,124,126,129

(Test Sample: .036"1/1)

| TEST ITEM | | Test Condition (IPC-TM-650 or As Noted) | UNIT | Specification (IPC-4101 B) | Typical Value | |
|---------------------------------|------------------|--|---------------------|-------------------------------|----------------------|-------------------------|
| | | | | | VT-47 | Normal FR-4 |
| Flexural Strength | Warp | 2.4.4 | MPa | >415 | 500 | 600 |
| | Fill | | | >345 | 420 | 500 |
| Peel Strength (1 oz) | As Receive | 2.4.8 | 1b/in | 6.0 min | 7~10 | 8.59 |
| | After Thermal | | | | 7~10 | 8.03 |
| Glass Transition Temp.(Tg),DSC | | 2.4.25 | °C | - | 170~185 | 136~140 |
| Decomposition Temp. (Td) TGA | | ASTM D3850 | °C | - | 345 | 290~310 |
| X-axis C.T.E. | | TMA | in/in/ °C | - | 11x10 ⁻⁶ | 12~15 x10 ⁻⁶ |
| Y-axis C.T.E. | | TMA | in/in/ °C | - | 13x10 ⁻⁶ | 12~15 x10 ⁻⁶ |
| Z-axis C.T.E. | Before Tg | TMA | in/in/ °C | ≤60x10 ⁻⁶ | 35x10 ⁻⁶ | 50x10 ⁻⁶ |
| | After Tg | | | ≤300x10 ⁻⁶ | 190x10 ⁻⁶ | 250x10 ⁻⁶ |
| Z-axis Total | 50→260°C | TMA | % | ≤3.5% | 3.0% | 3.5~4.0% |
| Expansion | 50→288°C | TMA | % | - | 3.0~3.5% | 4.0~5.0% |
| Moisture | D-24/23 | 2.6.21 | % | 0.35 max | 0.10~0.16 | 0.28 |
| Absorption | After PCT | 1atm.,121°C,1hour | % | - | 0.20 | 0.28 |
| Volume Resistance | After Moisture | 2.5.17.1 | MΩ-cm | ≥106 | 5×10 ⁸ | 5×10 ⁸ |
| | E-24/125 | | | ≥103 | 5×10 ⁶ | 5×10 ⁶ |
| Surface Resistance | After Moisture | 2.5.17.1 | MΩ | ≥104 | 5×10 ⁷ | 5×10 ⁷ |
| | E-24/125 | | | ≥103 | 5×10 ⁶ | 5×10 ⁶ |
| Electric Strength | | 2.5.6.2 | KV/mm (volt/mil) | ≥30 | 54 (1200~1400) | 54 |
| Dielectric Constant (Dk) | 1.0 MHz | 2.5.3, | - | 5.4 max. | 4.2-4.6 | 4.42 |
| | 1.0 GHZ | | | | 2.5.9, | 4.1-4.5 |
| | 2.0 GHZ | 2.5.5 | | | 4.0-4.3 | 4.38 |
| | 2.5 GHZ | | | | N/A | 4.36 |
| Dispersion Factor (Df) | 1.0 MHz | 2.5.3, | - | 0.035 max. | 0.015~0.020 | 0.022 |
| | 1.0 GHZ | | | | 2.5.9, | 0.015~0.018 |
| | 2.0 GHZ | 2.5.5 | | | 0.016~0.020 | 0.021 |
| | 2.5 GHZ | | | | 0.017~0.022 | 0.020 |
| Thermal Stress | 288°C,Sold Dip | 2.4.13.1 | Sec. | 60 Sec. | >300 | 90-120 |
| | 288°C,Sold Float | 2.4.13.1 | sec | / | >480 | 120~200 |
| Pressure Cook Test | | Pre-treat15psi/30min; 288°C,10Sec/cycle | Cycle | 2 cycles Min. | 10~12 | 6-8 |
| Time to Delamination---T260 | | 2.4.24.1 | Min | >30 | >60 | 18 |
| Time to Delamination---T288 | | 2.4.24.1 | Min | >5 | >10 | 3 |
| Flame Resistance | | UL94 | - | V1 | V0 | V0 |
| Comparative Tracking Index(CTI) | | UL-7461 ASTM D3638 | Voltage | — | 175~250 (Grade 3) | 175~250 (Grade 3) |

※ All test data provided are typical values and are not intended to be specification values.



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Process Guideline

Press Condition

1. Heating rate(Rise of Rate) of material:
Programmable Press: 1.5-3.0°C/min (3~5°F/min). Manual Press:3~6°C/min (5~10°F/min)
2. Curing Temperature & Time: >60min at more than 185°C (365°F)[Material Temperature].
3. Full Pressure: ≥250-300psi
4. Vacuuming should be continued until **over 140°C** (284°F) [Material Temperature]

Typical Drilling Parameters (φ0.3-1.0 mm)

| | | |
|-------------------|----------|------------|
| 1. Spindle Speed: | 120-180 | KRPM |
| 2. Feed Rate: | 120-220 | Inch / min |
| 3. Retract Rate: | 596-1000 | Inch / min |
| 4. Chip Load: | 0.6~2.0 | mil / Rev. |

The use of undercut drill bits has yielded better quality on smaller holes. Check with your drill supplier for more information.

Desmearing Process

Desmear rate of **VT-47** is less that of the conventional FR-4;
Minor adjustments to the desmear process may be necessary for the higher Tg materials.
Check with your chemical supplier for recommendations.